

2.8X0.8mm RIGHT ANGLE SMD CHIP LED **LAMP**

Part Number: AA2810AQWS/D

White



ATTENTION

OBSERVE PRECAUTIONS FOR HANDLING **ELECTROSTATIC** DISCHARGE SENSITIVE **DEVICES**

Features

- 2.8mmX0.8mm right angle SMT LED, 1.2mm thickness.
- Low power consumption.
- Ideal for backlight and indicator.
- Various colors and lens types available.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

Description

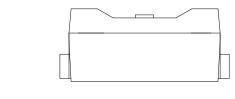
The source color devices are made with InGaN Light Emitting Diode.

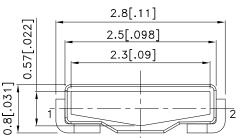
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

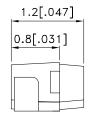
Package Dimensions

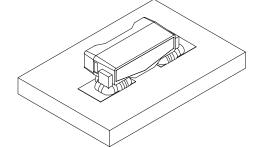












- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.1(0.0039") unless otherwise noted.
- 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.





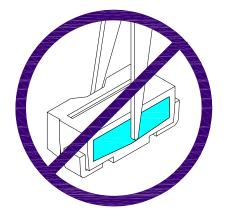
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Handling Precautions

Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might leads to damage and premature failure of the LED.

Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



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Selection Guide

Part No.	Dice	Lens Type	lv (mcd) [2] @ 20mA		Viewing Angle [1]
			Min.	Тур.	201/2
AA2810AQWS/D	White (InGaN)	WATER CLEAR	110	300	110°

- 1. 01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

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Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions	
VF [1]	Forward Voltage	White	3.3	4.0	V	IF=20mA	
lr	Reverse Current	White		10	uA	V _R = 5V	
X [2]	Chromaticity Coordinates	White	0.31				
Y [2]	Chromaticity Coordinates	vviille	0.31				
С	Capacitance	White	100		pF	VF=0V;f=1MHz	

- 1. Forward Voltage: +/-0.1V.
- 2: Measurement Tolerance Of The Chromaticity Coordinates Is ± 0.01 .

Absolute Maximum Ratings at TA=25°C

7. 1500 into maximum reasings at 171 20 0					
Parameter	White				
Power dissipation	120	mW			
DC Forward Current	30	mA			
Peak Forward Current [1]	150	mA			
Reverse Voltage	5	V			
Operating Temperature	-40°C To +85°C				
Storage Temperature	-40°C To +85°C				

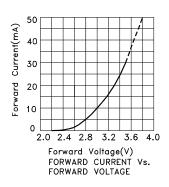
Note:

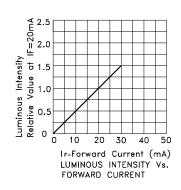
1. 1/10 Duty Cycle, 0.1ms Pulse Width.

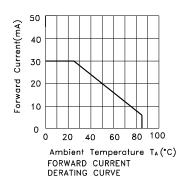
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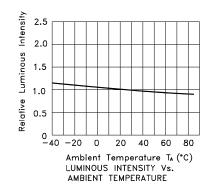
White

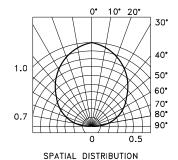
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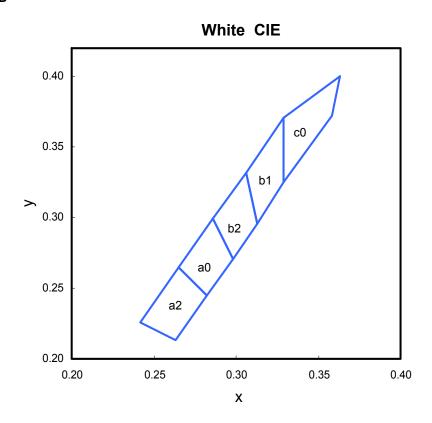






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	x	у		x	у		x	у
a2	0.263	0.213	а0	0.282	0.245	b2	0.298	0.271
	0.282	0.245		0.298	0.271		0.313	0.296
	0.265	0.265		0.286	0.299		0.306	0.332
	0.242	0.226		0.265	0.265		0.286	0.299
b1	0.313	0.296	c0	0.329	0.325			
	0.329	0.325		0.358	0.372			
	0.329	0.371		0.363	0.400			
	0.306	0.332		0.329	0.371			

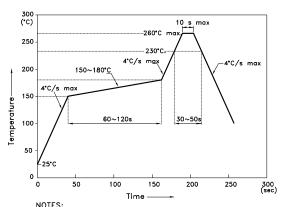
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

 1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

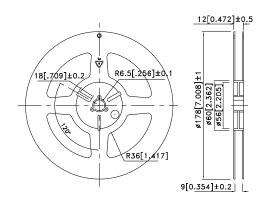
 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
 - to high temperature.

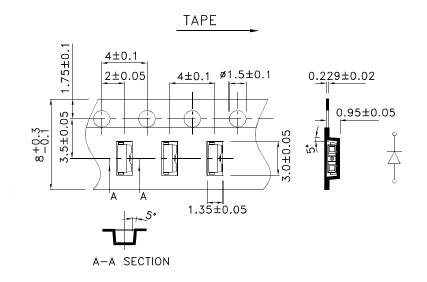
 3.Number of reflow process shall be 2 times or less.

Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)

Tape Dimensions (Units : mm)

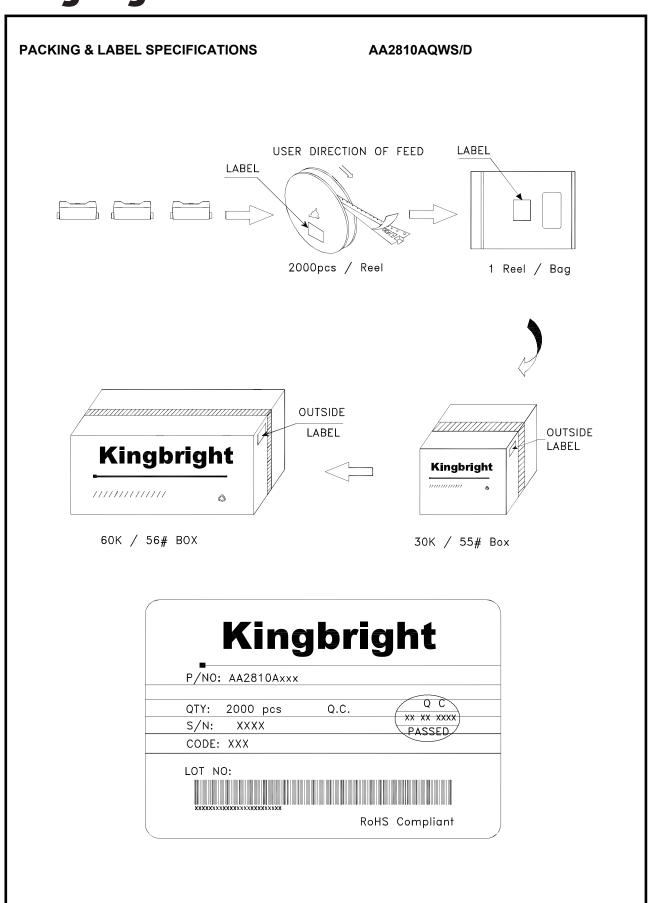
Reel Dimension





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